Proton radiation effect on InAs avalanche photodiodes

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Abstract: With increasing interest over the past decade in space-related remote sensing and communications using near-infrared (NIR) wavelengths, there is a need for radiation studies on NIR avalanche photodiodes (APDs), due to the high radiation environment in space. In this work, we present an experimental study of proton radiation effects on performance parameters of InAs APDs, whose sensitivity extends from visible light to ~3.5 μm. Three irradiation energies (10.0, 31.4, and 58.8 MeV) and four fluences (10^9 to 10^11 p/cm^2) were used. At the harshest irradiation condition (10.0 MeV energy and 10^11 p/cm^2 fluence) the APDs’ avalanche gain and leakage current showed a measurable degradation. However, the responsivity of the APDs was unaffected under all conditions tested. The data reported in this article is available from the figshare digital repository (DOI: https://dx.doi.org/10.15131/shef.data.4560562).

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References and links
1. Introduction

Remote monitoring of greenhouse gases such as CO₂, CH₄ and NO₂ with global coverage and high spatial resolution constitutes a major part of studying the Earth’s climate and its relationship with the changes introduced by human activities. Satellite-based atmospheric passive sounders using the infrared wavelengths provide gas concentration information mainly from the middle and upper troposphere due to their atmospheric weighting functions [1]. Using space-borne differential light detection and ranging (LIDAR) techniques, very accurate measurement of greenhouse gases within the lower troposphere, where the sinks and sources interact with the atmosphere, can be achieved [2, 3]. Hence differential LIDAR systems offer highly valuable information for the wider remote monitoring systems for greenhouse gases.

Performance of a differential LIDAR system for greenhouse gases depends on the performance of the laser and the optical detector used in the system as well as the operating wavelength. Considerations of atmospheric weighting functions that favor the lower troposphere, strong absorption peaks, optical depths and influence of temperature profile uncertainty on the deduced gas concentration led to several optimum wavelengths [2, 3]. These are ~1.6 μm (CO₂ and CH₄), ~2 μm (CO₂ and CH₄), and 3.9 μm (NO₂).

For operating wavelengths up to 1.6 μm, commercial detectors fabricated with In₀.₅₃Ga₀.₄₇As photon absorption layers have suitable performance characteristics and so can be utilized. Furthermore, since the differential LIDAR systems are required to detect very weak optical signals with fast sample speeds, use of In₀.₅₃Ga₀.₄₇As based APDs with acceptably low leakage currents can provide a marked improvement to the system’s overall signal-to-noise ratio compared to a system employing a unity gain detector. For detection up to ~2 μm, an APD with an In₀.₅₃Ga₀.₄₇As/ GaAs₀.₅₁Sb₀.₄₉ type-II superlattice absorber and an In₀.₅₂Al₀.₄₈As avalanche region was developed [4]. However photon absorption in type-II superlattice is an inherently inefficient process compared to direct bandgap materials. Hence APD technology based on type-II superlattice technologies is unlikely to yield quantum efficiency that is competitive with direct bandgap materials. Currently, the most promising APD technologies for ~2 μm wavelength detection are electron-APDs (e-APDs) made from either HgCdTe [5] or InAs [6, 7], both direct bandgap materials. These e-APDs provide avalanche gain without the usual penalty of avalanche noise, and their detection wavelengths extend up to 3.5 μm (InAs) or longer (depending on alloy composition of HgCdTe).

In addition to the usual APD performance parameters, when choosing APDs and designing radiation shields for space borne applications, considerations must be given to degradation of the APD performance brought on by exposure to radiation. Thus performance degradation of Si photodiodes and Si APDs due to radiation is well studied [8–10]. For infrared APDs, the only radiation damage study reported was on InGaAs/InP APDs and Ge APDs [11], even though there is a recent study on HgCdTe photodiodes (not e-APDs) [12]. For InAs, there has been no radiation report on either photodiodes or e-APDs.
Radiation damage studies carried out on Si, Ge and InGaAs/InP APDs concluded that the bulk of the noticeable radiation damage resulted from displacement damage [8–11]. Proton irradiation, which introduces ionization damage and displacement damage, is thus an appropriate choice of particles for such studies.

In this work, we investigate displacement damage effects on InAs APDs, by measuring changes in leakage current, responsivity and avalanche gain of the APDs subject to proton irradiation under three energies with four fluences.

2. Device fabrication and experimental detail

The InAs APDs used were grown by molecular beam epitaxy on a 2-inch n-type InAs substrate, with Be and Si as the p- and n- type dopant atoms. The epitaxial layers consist of a 300 nm p⁺-layer (InAs and AlAsSb), a 3.5 μm InAs layer with graded p-doping, a 6.0 μm InAs i-layer and a 1.0 μm InAs n-layer, as shown schematically in Fig. 1(a). Circular mesa APDs with diameters of 400, 200, 100 and 50 μm, shown in Fig. 1(b), were fabricated on a sample piece cleaved from the wafer. Device fabrication used standard photolithography, Ti/Au (20/200 nm thick) ohmic contacts, and wet chemical etching solutions [6]. Finally mesa sidewalls were passivated using negative photoresist SU 8, minimizing surface leakage current.

Pre-irradiation APD characterization, carried out at 300 and 200 K (the intended operating temperature), included dark current versus reverse bias (\(I_d-V\)) characteristics in the dark, avalanche gain versus reverse bias (\(M(V)\)) characteristics, and responsivity at −0.2 V. The measurements of \(M(V)\) and responsivity used modulated laser light at 1550 nm wavelength and phase-sensitive detection technique, to minimize influence of leakage currents. All measurements were carried out using probe stations so that no device packaging was needed for testing. When the pre-irradiation characterization was completed, the sample piece was cleaved into thirteen dies, labeled as Die #1 to Die #12, plus a reference die.

To investigate displacement damage, Dies 1 to 12 were irradiated by protons at the Proton Irradiation Facility at the Paul Scherrer Institute, whose staff performed the beam calibration and dosimetry. Three proton energies, 10.0, 31.4, and 58.8 MeV, and four fluences, \(\Phi\), \(10^9\) to \(10^{11}\) p/cm², were used, as summarized in Table 1. In semiconductor devices, the extent of displacement damage-related performance degradation often appears to correspond to non-ionizing energy loss (NIEL), the equivalent average energy loss per unit path length caused by non-ionizing events (e.g. displacements of atoms) [13]. Hence NIEL values calculated using software from [14] are included in Table 1 for reference.

<table>
<thead>
<tr>
<th>Proton Energy (MeV)</th>
<th>Proton NIEL (keV/(g/cm²))</th>
<th>Proton Fluence, (\Phi) (proton/cm²)</th>
<th>Damage factor, (\Delta I_d/\Phi) (nA cm⁻²/proton)</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>(10^7)</td>
<td>(5 \times 10^8)</td>
</tr>
<tr>
<td>10.0</td>
<td>6.04</td>
<td>#1</td>
<td>#2</td>
</tr>
<tr>
<td>31.4</td>
<td>3.66</td>
<td>#5</td>
<td>#6</td>
</tr>
<tr>
<td>58.8</td>
<td>3.85</td>
<td>#9</td>
<td>#10</td>
</tr>
</tbody>
</table>
The irradiations were undertaken at room temperature without biasing the APDs on the dies. After the irradiation, characterization was repeated on all irradiated APD dies and the reference die, using identical conditions and setups as for pre-radiation tests. The measurements were completed within two weeks of the irradiations.

A large number of APDs were measured prior to and after the irradiation, as summarized in Table 2. The $I_d-V$ characteristics covered the 400, 200 and 100 μm diameter APDs. The uniform dark current characteristics provide evidence of uniformity of APDs fabricated. Hence the $M(V)$ and responsivity measurements focused only on the 200 μm diameter APDs to ensure pure electron injection profiles are maintained in all measurements involving laser light, whilst dark currents remain sufficiently low. For each die, a minimum of 2 APDs were measured to obtain the mean $M(V)$ and responsivity. Hence all data shown are from the 200 μm diameter APDs. Sets of data obtained from the reference die prior to and after the proton irradiation were indistinguishable (within one standard deviation), confirming that the InAs APDs preserve their characteristics over the period so are sufficiently robust for proton irradiation effect(s) study.

Table 2. Number of APDs tested for each die prior to and after proton irradiation.

<table>
<thead>
<tr>
<th>Measurements</th>
<th>Before irradiation</th>
<th>After irradiation</th>
</tr>
</thead>
<tbody>
<tr>
<td>$I_d-V$</td>
<td>12</td>
<td>8-14</td>
</tr>
<tr>
<td>$M(V)$</td>
<td>$\geq 2$</td>
<td>$\geq 2$</td>
</tr>
<tr>
<td>Responsivity</td>
<td>$\geq 2$</td>
<td>$\geq 2$</td>
</tr>
</tbody>
</table>

3. APD performance prior to proton irradiation

Figure 2(a) and (b) plots the mean $I_d-V$ and the mean $M(V)$ characteristics, respectively, with standard deviations from pre-radiation measurements at 300 and 200 K for APDs with diameters of 200 μm. For these APDs at 200 K, the mean $I_d$ values were 150 nA at $-0.2$ V and 2.6 μA at $-10$ V. Dark currents at both temperatures were found to be dominated by diffusion currents, indicated by an activation energy, close to the bandgap, of 0.34 eV from temperature dependence analyses (temperature data points of 300, 250, 200 and 175 K).

The mean $M(V)$ characteristics with standard deviations at 300 and 200 K are compared in Fig. 2(b). The avalanche gain shows a positive temperature dependence, consistent with ref [15]. At 200 K, the avalanche gain at $-10.0$ V is $22.8 \pm 0.3$. Responsivity values, measured at $-0.2$ V, at 300 and 200 K are $0.62 \pm 0.01$ and $0.66 \pm 0.01$ A/W, respectively. As temperature decreases, the responsivity increases slightly, because of increased collection efficiency of photo-generated electrons (attributed to increased minority electron diffusion length in the top p-InAs layer).

Fig. 2. (a) Mean $I_V$ with standard deviations, and (b) mean $M(V)$ with standard deviations at 300 and 200 K of 200 μm diameter InAs APDs, prior to proton irradiation.
4. Dark currents after proton irradiation

In Fig. 3, mean $I_d$-$V$ characteristics at 300 and 200 K from 200 μm diameter APDs from all irradiated dies are compared to the reference data presented in Fig. 2(a). At 300 K, out of the 12 irradiated dies, only APDs from Die #4 ($10^{11}$ p/cm² at 10.0 MeV) showed a significant increase in dark current, at approximately 3 times larger compared to the reference APDs, at any given voltage. Observing Fig. 3(bottom row), the 200 K $I_d$-$V$ characteristics comparisons reveal more significant degradation. Taking into account the error bars of the reference data, the 10.0 MeV proton irradiations cause degradation at any given voltage for the two largest $\Phi$ tested. For other proton energies, the $I_d$-$V$ characteristic degrades only when the highest $\Phi$ was used, with the increase in $I_d$ being voltage dependent.

Plotting the 200 K $I_d$ values at $-0.2$ V and $-10$ V against $\Phi$ in Fig. 4(a) confirms that the 10.0 MeV protons caused the most significant degradation of $I_d$, followed by the 58.8 MeV protons and finally the 31.4 MeV protons.
Next we analyze the increase in 200 K dark currents (with respect to the reference APDs), \( \Delta I_d \), versus \( \Phi \). For Dies #1, #2, #3, and #4 (10.0 MeV), \( \Delta I_d \) are shown in Fig. 4(b), for reverse bias of \(-0.2\) and \(-10\) V. For a given reverse bias, the data can be fitted with a linear equation with \( \Delta I_d / \Phi \) as the gradients. Values of \( \Delta I_d / \Phi \) for the 200 \( \mu \)m diameter APDs cooled to 200 K at \(-0.2\) and \(-10\) V are given in Table 1. A larger reverse bias produced a larger \( \Delta I_d / \Phi \), which is at least partially caused by a higher \( M \) amplifying \( \Delta I_d \), and a wider depletion region (from 1.9 to 7.6 \( \mu \)m) that increases the number of damage-related defects [8].

When higher proton energy was used, the dark current increases beyond the error bars of the reference data only when fluence of \( 10^{11} \) p/cm\(^2\) was used (Dies #8 and #12). Thus the damage threshold fluence for dark current at 31.8 and 58.8 MeV proton energy is noticeable higher than that at 10.0 MeV.

To assess possible unbiased room temperature annealing, a further round of post irradiation 200 K dark current measurements on the reference die, Die #3, and Die #4 was carried out 4 months after the irradiations (results not shown here). The dies were kept at room temperature in between both sets of tests. At \(-0.2\) V, the dark currents of all APDs were found to be indistinguishable from the measurements carried out within the first 2 weeks of proton irradiation. At \(-10.0\) V, the reference die had a mean dark current of \(-2.6\) \( \mu \)A (200 \( \mu \)m diameter APD), which is consistent with Fig. 3 showed negligible change. At the same reverse bias voltage, the dark currents of APDs from Die #3 and Die #4 were found to decrease from 7.8 to 4.2 \( \mu \)A and 21 to 13 \( \mu \)A, respectively. The extent of the recovery is significant, however, APDs from both dies still had higher dark currents than the reference APDs by a factor of \(-1.6\) and \(-5.2\), respectively.

5. Responsivity and \( M(V) \) after proton irradiation

Despite the radiation-induced bulk damage causing an increase in dark current for some of the dies, the intrinsic photon absorption and photo-generated current collection efficiency in the InAs APDs appears to be unaffected. This is evidenced by the negligible difference in responsivity values (taken at \(-0.2\) V) before and after the proton irradiation, as compared in Figs. 5(a) and 5(b), for 300 and 200 K, respectively.

![Fig. 5. Responsivity at \(-0.2\) V of the dies at (a) 300 and (b) 200 K, compared to the reference values (with standard deviations).](image-url)
6. Damage analysis

Using a different pair of InAs APD samples with Be-doped p-layer and thick i-layers, Transmission Electron Microscopy (TEM) studies were carried out as part of this work. One of the samples was irradiated at the same time as Die #4, which has shown the worst degradation in device performance, and the other was not irradiated so serves as a reference sample.

To observe the presence of radiation-induced defects in the samples, 220 bright field TEM images were taken from both samples. The reference sample was found to be free of extended defects. However, the TEM image of the irradiated sample revealed dislocation loops in the p-doped InAs layer (within 750 nm from the top of the sample), as shown in Fig. 7(a). These loops were further studied using high-resolution TEM (HREM). In all of them, a Moiré fringe area was identified as a precipitate that gives rise to the dislocation loop [16]. A typical HREM image of a dislocation loop in Fig. 7(a) is shown in Fig. 7(b), where a rectangle and a dotted ellipse indicate the Moiré fringe area and the dislocation loop, respectively. These defects are likely to be present in Die #4 too, so may have contributed to the increased dark currents and altered $M(V)$ characteristics (Sections 5 and 6).
7. Conclusions

An experimental study of effects of proton irradiation on InAs APDs developed for detecting 2 to 3 μm wavelength light was conducted. The study used InAs APDs with a mesa topology and assessed dark current, avalanche gain and responsivity, measured at 300 and 200 K. Of the three parameters, the dark currents showed the most significant degradation. At 300 K, only the harshest irradiation condition (10.0 MeV energy and 10^{11} p/cm²fluence) caused an increase in dark currents. At 200K, however, dark currents increased when proton energy was 10.0 MeV and fluence reached 10^{10} p/cm². With proton energies of 31.8 and 58.8 MeV, the damage threshold for dark current was higher (fluence ≥ 10^{11} p/cm²).

No noticeable change was found for responsivity, despite presence of dislocation loops within the p-InAs layer of the sample irradiated with the harshest condition. For avalanche gain, none of the irradiation conditions resulted in degradation, except for a slight change for the harshest condition. At 10.0 MeV and fluence of 10^{11} p/cm², the avalanche gain at −10.0 V and 200 K reduced from 22.8 to 20.8.

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